74ABT657

Octal transceiver with parity generator/checker; 3-state

Rev. 03 — 15 March 2010

Product data sheet

1. General description

The 74ABT657 high-performance BiCMOS device combines low static and dynamic power dissipation with high speed and high output drive.

The 74ABT657 is an octal transceiver featuring non-inverting buffers with 3-state outputs and an 8-bit parity generator/checker, and is intended for bus-oriented applications. The buffers have a guaranteed current sinking capability of 64 mA. The Transmit/Receive input (pin T/\overline{R}) determines the direction of the data flow through the bidirectional transceivers. Transmit (active HIGH) enables data from A ports to B ports; Receive (active LOW) enables data from B ports to A ports.

When Output Enable input (pin \overline{OE}) is HIGH, both A and B ports are high-impedance. The parity select input (pin ODD/ \overline{EVEN}) allows the user to generate either an odd or even parity output, depending on the system. Pin PARITY is an output from the generator/checker when transmitting from port A to port B (pin $T/\overline{R} = HIGH$) and an input when receiving from port B to port A port (pin $T/\overline{R} = LOW$).

In transmit mode (pin $T/\overline{R} = HIGH$) port A is polled to determine the number of HIGH inputs on port A. Pin PARITY output goes to the logic state determined by the setting of pin ODD/ \overline{EVEN} and by the number of HIGH inputs on port A. For example, if pin ODD/ \overline{EVEN} is set LOW (even parity) and the number of HIGH inputs on port A is odd, pin PARITY output goes HIGH, transmitting even parity. If the number of HIGH inputs on port A is even, pin PARITY output goes LOW, keeping even parity.

In receive mode (pin $T/\overline{R} = LOW$) port B is polled to determine the number of HIGH inputs on port B. If pin ODD/ \overline{EVEN} is LOW (even parity) and the number of HIGH inputs on port B is:

- Odd and pin PARITY input is HIGH, pin ERROR is HIGH, indicating no error
- Even and pin PARITY input is HIGH, pin ERROR goes LOW, indicating an error

2. Features and benefits

- Combinational functions in one package
- Low static and dynamic power dissipation with high speed and high output drive
- Output capability: +64 mA and -32 mA
- Power-up 3-state
- Latch-up protection exceeds 500 mA per JESD78B class II level A
- ESD protection:
 - ◆ HBM JESD22-A114F exceeds 2000 V
 - ◆ MM JESD22-A115-A exceeds 200 V



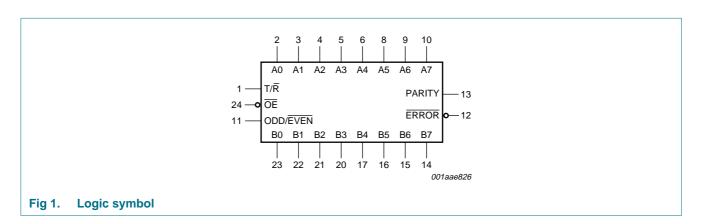
Octal transceiver with parity generator/checker; 3-state

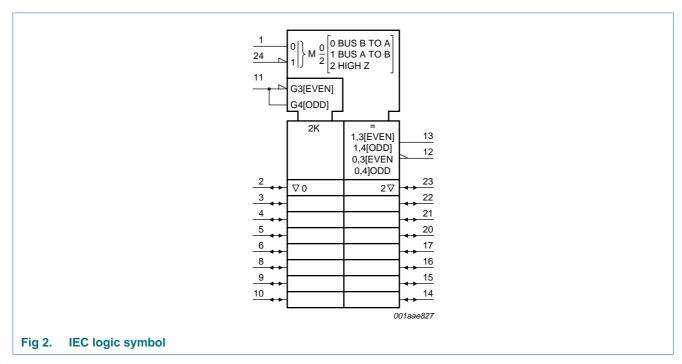
3. Ordering information

Table 1. Ordering information

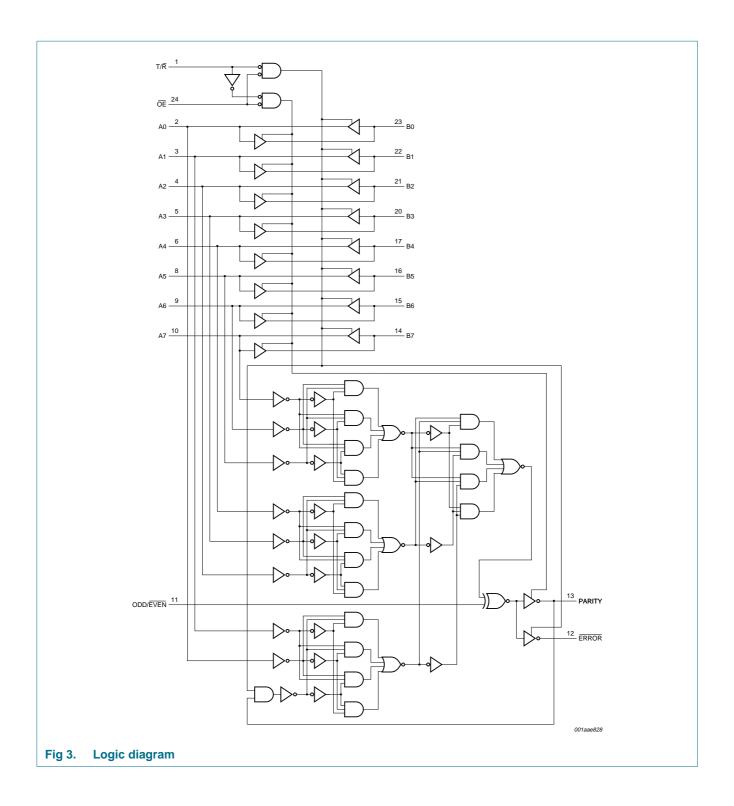
Type number	Package										
	Temperature range	Name	Description	Version							
74ABT657D	–40 °C to +85 °C	SO24	plastic small outline package; 24 leads; body width 7.5 mm	SOT137-1							
74ABT657DB	–40 °C to +85 °C	SSOP24	plastic shrink small outline package; 24 leads; body width 5.3 mm	SOT340-1							
74ABT657PW	–40 °C to +85 °C	TSSOP24	plastic thin shrink small outline package; 24 leads; body width 4.4 mm	SOT355-1							

4. Functional diagram





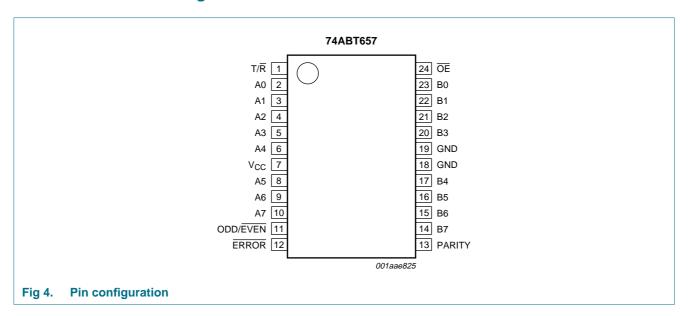
Octal transceiver with parity generator/checker; 3-state



Octal transceiver with parity generator/checker; 3-state

5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
T/R	1	transmit/receive input
A0 to A7	2, 3, 4, 5, 6, 8, 9, 10	A port input/3-state output
V _{CC}	7	positive supply voltage
ODD/EVEN	11	parity select input
ERROR	12	error output in receive mode
PARITY	13	parity output in transmit mode/input in receive mode
B0 to B7	23, 22, 21, 20, 17, 16, 15, 14	B port input/3-state output
GND	18, 19	ground (0 V)
ŌĒ	24	output enable input (active LOW)

Octal transceiver with parity generator/checker; 3-state

6. Functional description

6.1 Function selection

Table 3. Function selection[1]

Number of	Inputs			Data I/O	Output	
inputs HIGH	OE	T/R	ODD/EVEN	PARITY	ERROR	Mode
0, 2, 4, 6 and 8	L	Н	Н	Н	Z	transmit
(even)	L	Н	L	L	Z	transmit
	L	L	Н	Н	Н	receive
	L	L	Н	L	L	receive
	L	L	L	Н	L	receive
	L	L	L	L	Н	receive
1, 3, 5 and 7	L	Н	Н	L	Z	transmit
(odd)	L	Н	L	Н	Z	transmit
	L	L	Н	Н	L	receive
	L	L	Н	L	Н	receive
	L	L	L	Н	Н	receive
	L	L	L	L	L	receive
Don't care	Н	X	Χ	Z	Z	3-state

^[1] H = HIGH voltage level;

L = LOW voltage level;

X = don't care;

Z = high-impedance OFF-state.

Octal transceiver with parity generator/checker; 3-state

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+7.0	V
V_{I}	input voltage		<u>[1]</u> –1.2	+7.0	V
V_{O}	output voltage	output in OFF-state or HIGH-state	<u>[1]</u> –0.5	+5.5	V
I _{IK}	input clamping current	V _I < 0 V	-18	-	mA
I_{OK}	output clamping current	V _O < 0 V	-50	-	mA
I _O	output current	output in LOW-state	-	128	mA
Tj	junction temperature		[2] _	150	°C
T_{stg}	storage temperature		-65	+150	°C

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CC}	supply voltage		4.5	-	5.5	V
V_{I}	input voltage		0	-	V_{CC}	V
V _{IH}	HIGH-level input voltage		2.0	-	-	V
V _{IL}	LOW-level input voltage		-	-	0.8	V
I_{OH}	HIGH-level output current		-32	-	-	mA
I _{OL}	LOW-level output current		-	-	64	mA
$\Delta t/\Delta V$	input transition rise and fall rate		0	-	5	ns/V
T _{amb}	ambient temperature	in free air	-40	-	+85	°C

^[2] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150 °C.

Octal transceiver with parity generator/checker; 3-state

9. Static characteristics

Table 6. Static characteristics

Symbol	Parameter	Conditions			25 °C		–40 °C t	o +85 °C	Uni
				Min	Тур	Max	Min	Max	
V _{IK}	input clamping voltage	$V_{CC} = 4.5 \text{ V}; I_{IK} = -18 \text{ mA}$		-1.2	-0.9	-	-1.2	-	V
V _{OH}	HIGH-level output	$V_I = V_{IL}$ or V_{IH}							
	voltage	$V_{CC} = 4.5 \text{ V}; I_{OH} = -3 \text{ mA}$		2.5	3.5	-	2.5	-	V
		$V_{CC} = 5.0 \text{ V}; I_{OH} = -3 \text{ mA}$		3.0	4.0	-	3.0	-	V
		$V_{CC} = 4.5 \text{ V}; I_{OH} = -32 \text{ mA}$		2.0	2.6	-	2.0	-	V
V_{OL}	LOW-level output voltage	V_{CC} = 4.5 V; I_{OL} = 64 mA; $V_I = V_{IL}$ or V_{IH}		-	0.42	0.55	-	0.55	V
l _l	input leakage current	$V_{CC} = 5.5 \text{ V}; V_I = \text{GND or } 5.5 \text{ V}$							
		control pins		-	±0.01	±1.0	-	±1.0	μΑ
		data pins		-	±5	±100	-	±100	μΑ
I _{OFF}	power-off leakage current	V_{CC} = 0 V; V_{I} or $V_{O} \le 4.5$ V		-	±5.0	±100	-	±100	μΑ
O(pu/pd)	power-up/power-down output current	V_{CC} = 2.0 V; V_{O} = 0.5 V; V_{I} = GND or V_{CC} ; \overline{OE} HIGH	<u>[1]</u>	-	±5.0	±50	-	±50	μΑ
l _{OZ}	OFF-state output current	V_{CC} = 5.5 V; V_I = V_{IL} or V_{IH}							
		$V_0 = 2.7 \text{ V}$		-	5.0	50	-	50	μΑ
		$V_0 = 0.5 \text{ V}$		-	-5.0	-50	-	-50	μΑ
I _{LO}	output leakage current	HIGH-state; $V_O = 5.5 \text{ V}$; $V_{CC} = 5.5 \text{ V}$; $V_I = \text{GND or } V_{CC}$		-	5.0	50	-	50	μΑ
lo	output current	$V_{CC} = 5.5 \text{ V}; V_{O} = 2.5 \text{ V}$	[2]	-180	-100	-50	-180	-50	mΑ
I _{CC}	supply current	V_{CC} = 5.5 V; V_I = GND or V_{CC}							
		outputs HIGH-state		-	0.5	250	-	250	μΑ
		outputs LOW-state		-	20	30	-	30	mΑ
		outputs disabled		-	0.5	250	-	250	μΑ
Δl _{CC}	additional supply current	per input pin; V_{CC} = 5.5 V; one input at 3.4 V; other inputs at V_{CC} or GND	[3]						
		outputs enabled		-	0.5	1.5	-	1.5	mΑ
		outputs 3-state, one data input		-	50	250	-	250	μΑ
		outputs 3-state; one enable input		-	0.5	1.5	-	1.5	mΑ
Cı	input capacitance	$V_I = 0 \text{ V or } V_{CC}$		-	4	-	-	-	pF
C _{I/O}	input/output capacitance	outputs disabled; $V_O = 0 \text{ V or } V_{CC}$		-	7	-	-	-	рF

^[1] This parameter is valid for any V_{CC} between 0 V and 2.1 V with a transition time of up to 10 ms. For V_{CC} = 2.1 V to V_{CC} = 5 V \pm 10 %, a transition time of up to 100 μ s is permitted.

^[2] Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

^[3] This is the increase in supply current for each input at 3.4 V.

Octal transceiver with parity generator/checker; 3-state

10. Dynamic characteristics

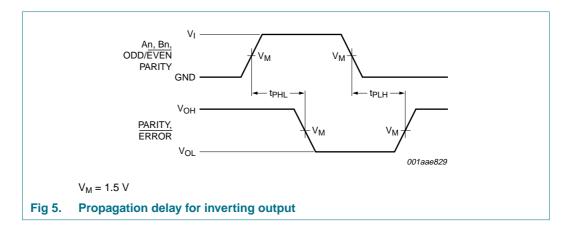
Table 7. Dynamic characteristics *GND = 0 V; for test circuit, see Figure 9.*

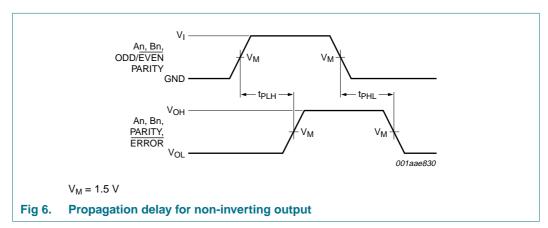
Symbol	Parameter	Conditions		25 °C;	V _{CC} =	5.0 V		> +85 °C; V ± 0.5 V	Unit
				Min	Тур	Max	Min	Max	
t_{PLH}	LOW to HIGH	An to Bn or Bn to An; see Figure 6		1.1	2.5	4.1	1.1	4.6	ns
	propagation delay	An to PARITY; see Figure 5 and 6		2.5	5.1	6.7	2.5	8.1	ns
		ODD/ $\overline{\text{EVEN}}$ to PARITY and $\overline{\text{ERROR}}$; see $\underline{\text{Figure 5}}$ and $\underline{\text{6}}$		1.7	3.5	4.6	1.7	5.3	ns
		Bn to ERROR; see Figure 5 and 6		3.9	7.3	10.2	3.9	12.3	ns
		PARITY to ERROR; see Figure 5 and 6		2.7	4.5	5.9	2.7	7.7	ns
t _{PHL} HIGH to LOW		An to Bn or Bn to An; see Figure 6		1.2	3.0	3.9	1.2	4.3	ns
	propagation delay	An to PARITY; see Figure 5 and 6		2.8	5.0	7.4	2.8	8.9	ns
		ODD/ $\overline{\text{EVEN}}$ to PARITY and $\overline{\text{ERROR}}$; see $\underline{\text{Figure 5}}$ and $\underline{\text{6}}$		1.9	3.7	5.1	1.9	5.8	ns
		Bn to ERROR; see Figure 5 and 6		4.0	7.9	10.5	4.0	12.9	ns
		PARITY to ERROR; see Figure 5 and 6		3.2	5.2	6.7	3.2	8.1	ns
t _{PZH}	OFF-state to HIGH propagation delay	see Figure 7 and 8	[1]	1.3	3.6	5.5	1.3	6.5	ns
t_{PZL}	OFF-state to LOW propagation delay	see Figure 7 and 8	<u>[1]</u>	1.9	4.2	5.3	1.9	6.5	ns
t _{PHZ}	HIGH to OFF-state propagation delay	see Figure 7 and 8		2.4	3.6	5.6	2.4	6.2	ns
t _{PLZ}	LOW to OFF-state propagation delay	see Figure 7 and 8		2.2	3.4	7.3	2.2	7.8	ns

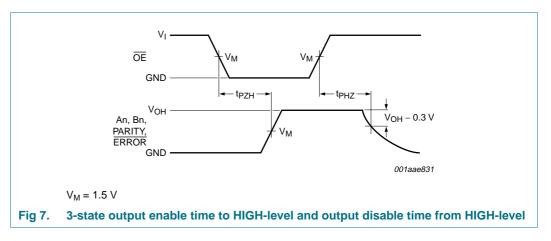
^[1] These delay times reflect the 3-state recovery time only and do not include the delay through the buffers and the parity check circuitry which affect the ERROR output. To ensure **valid** information at the ERROR pin, time must be allowed for the signal to propagate through the drivers (B to A), through the parity check circuitry (same as A to PARITY), and to the ERROR output. **Valid** data at the ERROR pin ≥ (B to A) + (A to PARITY).

Octal transceiver with parity generator/checker; 3-state

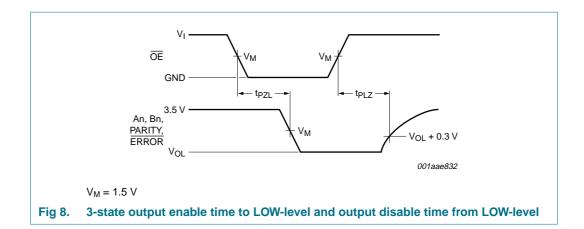
11. Waveforms



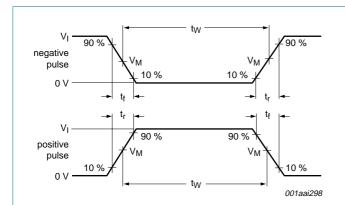


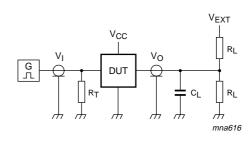


Octal transceiver with parity generator/checker; 3-state



b. Test circuit





a. Input pulse definition

Test data and V_{EXT} levels are given in Table 8.

R_L = Load resistance.

C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

 V_{EXT} = Test voltage for switching times.

Fig 9. Test circuit for measuring switching times

Table 8. Test data

Input				Load		V _{EXT}			
VI	f_l t_W t_r , t_f				R_L	t _{PHL} , t _{PLH}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}	
3.0 V	1 MHz	500 ns	\leq 2.5 ns	50 pF	$500~\Omega$	open	open	7.0 V	

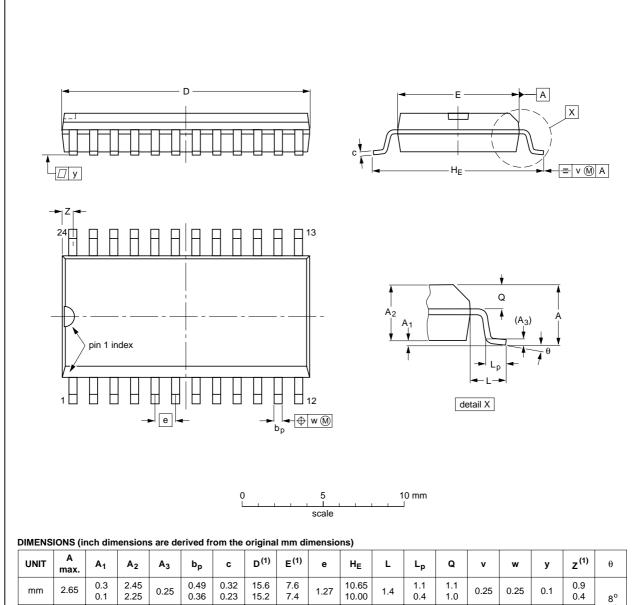
74ABT657 **NXP Semiconductors**

Octal transceiver with parity generator/checker; 3-state

12. Package outline

SO24: plastic small outline package; 24 leads; body width 7.5 mm

SOT137-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Ø	٧	w	у	z ⁽¹⁾	θ
mm	2.65	0.3 0.1	2.45 2.25	0.25	0.49 0.36	0.32 0.23	15.6 15.2	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8°
inches	0.1	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.61 0.60	0.30 0.29	0.05	0.419 0.394	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	0°

Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	1330E DATE
SOT137-1	075E05	MS-013			-99-12-27 03-02-19

Fig 10. Package outline SOT137-1 (SO24)

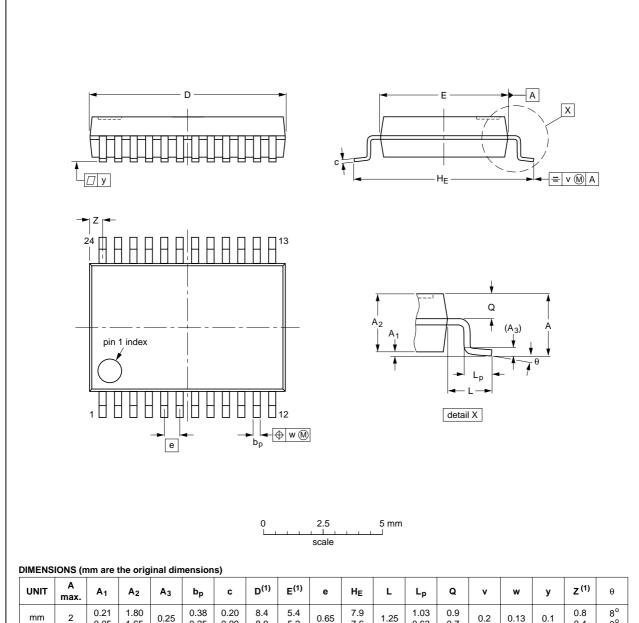
All information provided in this document is subject to legal disclaimers.

74ABT657 **NXP Semiconductors**

Octal transceiver with parity generator/checker; 3-state

SSOP24: plastic shrink small outline package; 24 leads; body width 5.3 mm

SOT340-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	ø	v	w	у	Z ⁽¹⁾	θ
mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	8.4 8.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.8 0.4	8° 0°

Note

1. Plastic or metal protrusions of 0.2 mm maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT340-1		MO-150			99-12-27 03-02-19
				· · · · · · · · · · · · · · · · · · ·	

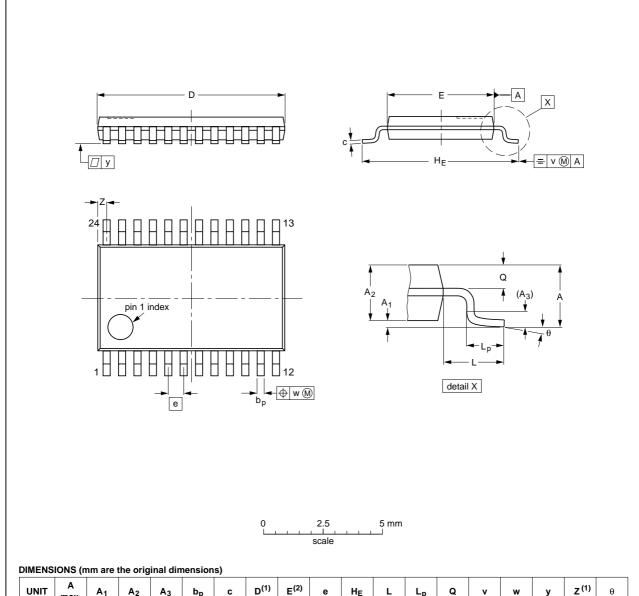
Fig 11. Package outline SOT340-1 (SSOP24)

All information provided in this document is subject to legal disclaimers.

Octal transceiver with parity generator/checker; 3-state

TSSOP24: plastic thin shrink small outline package; 24 leads; body width 4.4 mm

SOT355-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	C	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	7.9 7.7	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

VERSION IEC JEDEC JEITA PROJECTION SOT355-1 MO-153	OUTLINE		REFER	EUROPEAN	ISSUE DATE		
SOT355-1 MO-153	VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
- 150 150 1 mile 150	SOT355-1		MO-153				99-12-27 03-02-19

Fig 12. Package outline SOT355-1 (TSSOP24)

74ABT657_3

All information provided in this document is subject to legal disclaimers.

Octal transceiver with parity generator/checker; 3-state

13. Abbreviations

Table 9. Abbreviations

Acronym	Description
BiCMOS	Bipolar Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model

14. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74ABT657_3	20100315	Product data sheet	-	74ABT657_2
Modifications:	 The format of to of NXP Semicon 		esigned to comply with	n the new identity guidelines
	 Legal texts have 	e been adapted to the new	company name where	appropriate.
	 DIP 24 (SOT22 "Package outling") 	22-1) package removed from ne".	Section 3 "Ordering in	nformation" and Section 12
74ABT657_2	20041027	Product specification	-	74ABT657
74ABT657	19951211	Product specification	-	-

Octal transceiver with parity generator/checker; 3-state

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

15.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

15.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use in automotive applications — This NXP Semiconductors product has been qualified for use in automotive applications. The product is not designed, authorized or warranted to be

suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on a weakness or default in the customer application/use or the application/use of customer's third party customer(s) (hereinafter both referred to as "Application"). It is customer's sole responsibility to check whether the NXP Semiconductors product is suitable and fit for the Application planned. Customer has to do all necessary testing for the Application in order to avoid a default of the Application and the product. NXP Semiconductors does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

15.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

74ABT657_3

All information provided in this document is subject to legal disclaimers.

74ABT657 **NXP Semiconductors**

Octal transceiver with parity generator/checker; 3-state

16. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

Octal transceiver with parity generator/checker; 3-state

17. Contents

1	General description
2	Features and benefits
3	Ordering information
4	Functional diagram 2
5	Pinning information 4
5.1	Pinning
5.2	Pin description
6	Functional description 5
6.1	Function selection 5
7	Limiting values 6
8	Recommended operating conditions 6
9	Static characteristics 7
10	Dynamic characteristics 8
11	Waveforms
12	Package outline
13	Abbreviations
14	Revision history 14
15	Legal information
15.1	Data sheet status
15.2	Definitions
15.3	Disclaimers
16	Contact information
17	Contents 17

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP B.V. 2010.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com